

## LM9071 Low-Dropout System Voltage Regulator with Delayed Reset

Check for Samples: [LM9071](#)

### FEATURES

- Automotive Application Reliability
- 3% Output Voltage Tolerance
- Insensitive to Radiated RFI
- Dropout Voltage Less than 800 mV with 250 mA Output Current
- Externally Programmed Reset Delay Interval
- Thermal Shutdown
- Short Circuit Protection
- Reverse Battery Protection
- Wide Operating Temperature Range  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$
- TO-220 and TO-263 Power Surface Mount Power Packages
- Pin for Pin Compatible with the LM2927, L4947 and TLE4260

### DESCRIPTION

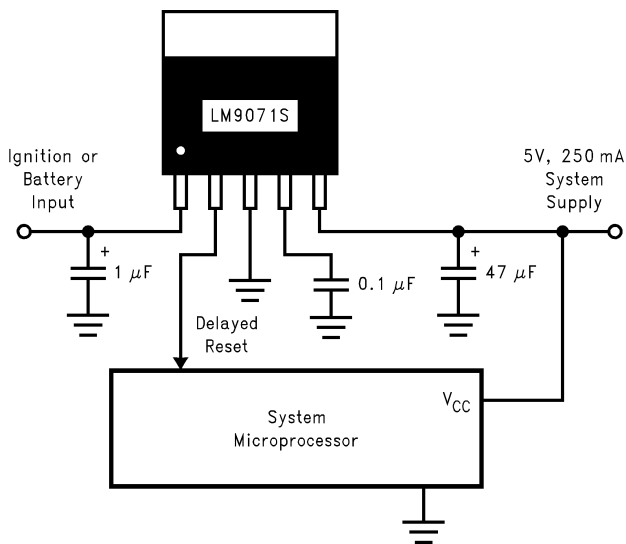
The LM9071 is a 5V, 250 mA low-dropout voltage regulator. The regulator features an active low delayed reset output flag which can be used to reset a microprocessor system on turn-ON and in the event that the regulator output falls out of regulation for any reason. An external capacitor programs a delay time interval before the reset output can return high.

Designed for automotive application the LM9071 contains a variety of protection features such as reverse battery, over-voltage shutdown, thermal shutdown, input transient protection and a wide operating temperature range.

Design techniques have been employed to allow the regulator to remain operational and not generate false reset signals when subjected to high levels of RF energy (300V/m from 2 MHz to 400 MHz).

### Typical Application and Connection Diagrams

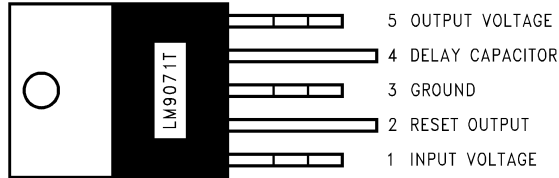
(Top View)


**Figure 1.**

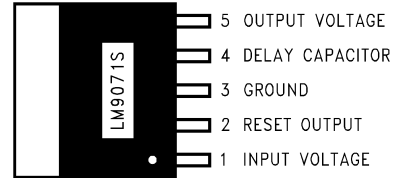
**Figure 2. 5-Lead TO-220 Package  
Package Number KC0005A**


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**Figure 3. 5-Lead TO-220 Package  
Package Number NDH0005D**



Tab and Backside metal on all packages internally connected to ground.

**Figure 4. 5-Lead TO-263 Surface Mount Package  
Package Number KTT0005B**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### Absolute Maximum Ratings <sup>(1)</sup>

|  |                    |
|--|--------------------|
| DC Input Voltage                         | -26V to +40V       |
| Positive Input Transient (t<100 ms)      | 60V                |
| Negative Input Transient (t<1 ms)        | -50V               |
| Reset Output Sink Current                | 5 mA               |
| Power Dissipation                        | Internally Limited |
| Junction Temperature                     | 150°C              |
| ESD Susceptibility <sup>(2)</sup>        | 12 kV, 2 kV        |
| Lead Temperature (Soldering, 10 seconds) | 260°C              |
| Storage Temperature                      | -50°C to +150°C    |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and conditions, see the Electrical Characteristics.
- (2) All pins will survive an ESD impulse of  $\pm 2000V$  using the human body model of 100 pF discharged through a 1.5 k $\Omega$  resistor. In addition the input voltage pin will withstand ten pulses of  $\pm 12$  kV from a 150 pF capacitor discharged through a 560 $\Omega$  resistor when bypassed with a 22 nF, 100V capacitor.

### Operating Ratings <sup>(1)</sup>

|  |                 |
|--|-----------------|
| Input Voltage  | 6V to 26V       |
| Ambient Temperature                                      | -40°C to +125°C |
| TO-220 Thermal Resistance, $\theta_{J-C}$                | 3°C/W           |
| TO-220 Thermal Resistance, $\theta_{J-A}$ <sup>(2)</sup> | 73°C/W          |
| TO-263 Thermal Resistance, $\theta_{J-C}$                | 3°C/W           |
| TO-263 Thermal Resistance, $\theta_{J-A}$ <sup>(3)</sup> | 80°C/W          |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and conditions, see the Electrical Characteristics.
- (2) Exceeding the Maximum Allowable power dissipation will cause excessive die temperature, and the device will go into thermal shutdown. The  $\theta_{J-A}$  value for the TO-220 package (still air, no additional heat sink) is 73°C/W. The effective  $\theta_{J-A}$  value of the TO-220 package can be reduced by using conventional heat sink methods.
- (3) Exceeding the Maximum Allowable power dissipation will cause excessive die temperature, and the device will go into thermal shutdown. The  $\theta_{J-A}$  value for the TO-263 package (still air, no additional heat sink) is 80°C/W. The effective  $\theta_{J-A}$  value of the TO-263 package can be reduced by increasing the printed circuit board area that is connected (soldered) to the package tab. Using 1 ounce (1.4 mils thick) copper clad with no solder mask, an area of 0.5 square inches will reduce  $\theta_{J-A}$  to 50°C/W, an area of 1.0 square inches will reduce  $\theta_{J-A}$  to 37°C/W, and an area of 1.6 square inches will reduce  $\theta_{J-A}$  to 32°C/W. If the printed circuit board uses a solder mask, the copper clad area should be increased by at least 50% to maintain a similar  $\theta_{J-A}$  rating.

## Electrical Characteristics <sup>(1)</sup>

The following specifications apply for  $V_{CC} = 6V$  to  $26V$ ,  $-40^{\circ}C \leq T_A \leq +125^{\circ}C$ , unless otherwise specified.  $C_{OUT} = 47\mu F$  with an  $ESR < 3\Omega$ .  $C_{IN} = 1\mu F$ .

| Symbol                  | Parameter                        | Conditions  | Min           | Max  | Units      |
|-------------------------|----------------------------------|---|---------------|------|------------|
| <b>REGULATOR OUTPUT</b> |                                  |   |               |      |            |
| $V_{OUT}$               | Output Voltage                   | $5\text{ mA} \leq I_{OUT} \leq 250\text{ mA}$   | 4.85          | 5.15 | V          |
| $\Delta V_{OUT}$ Line   | Line Regulation                  | $I_{OUT} = 5\text{ mA}$ , $9V \leq V_{IN} \leq 16.5V$                                 |               | 25   | mV         |
|                         |                                  | $I_{OUT} = 250\text{ mA}$   |               | 50   | mV         |
| $\Delta V_{OUT}$ Load   | Load Regulation                  | $V_{IN} = 14.4V$ , $5\text{ mA} \leq I_{OUT} \leq 250\text{ mA}$                      |               | 60   | mV         |
| $I_q$                   | Quiescent Current                | $I_{OUT} = 5\text{ mA}$   |               | 4    | mA         |
|                         |                                  | $I_{OUT} = 250\text{ mA}$ , $V_{IN} \geq 8V$  |               | 25   | mA         |
|                         |                                  | $I_{OUT} = 5\text{ mA}$ , $V_{IN} = 5V$   |               | 10   | mA         |
|                         |                                  | $I_{OUT} = 250\text{ mA}$ , $V_{IN} = 6V$   |               | 50   | mA         |
| $V_{do}$                | Dropout Voltage                  | $I_{OUT} = 5\text{ mA}$   |               | 300  | mV         |
|                         |                                  | $I_{OUT} = 250\text{ mA}$   |               | 800  | mV         |
| $I_{sc}$                | Short Circuit Current            | $R_L = 1\Omega$   | 0.35          | 1.5  | A          |
| PSRR                    | Ripple Rejection                 | $V_{IN} = (14V_{DC}) + (1V_{RMS} @ 120Hz)$<br>$I_{OUT} = 50\text{ mA}$                | 60            |      | dB         |
| OVthr                   | Overvoltage Shutdown Threshold   |   | 27            |      | V          |
| $V_O$ Transient         | $V_{OUT}$ during Transients      | $V_{IN}$ Peak $\leq 60V$ , $R_L = 100\Omega$ , $\tau = 100\text{ ms}$                 |               | 7    | V          |
| $V_O$ Rev Batt          | $V_{OUT}$ during Reverse Battery | $V_{IN} = -15V$   | -0.8          | 0.0  | V          |
| <b>RESET OUTPUT</b>     |                                  |   |               |      |            |
| $V_{th}$                | Threshold Voltage                | $\Delta V_{OUT}$ Required to Generate a Reset Output<br>$4.8V \leq V_{OUT} \leq 5.2V$ | -300          | -500 | mV         |
| $V_{low}$               | Reset Output Low Voltage         | $I_{sink} = 1.6\text{ mA}$ , $V_{OUT} > 3.2V$   |               | 0.4  | V          |
|                         |                                  | $1.4V \leq V_{OUT} \leq 3.2V$   |               | 0.8  | V          |
| $V_{high}$              | Reset Output High Voltage        |   | $0.8 V_{OUT}$ |      | V          |
| $t_{DELAY}$             | Delay Time                       | $C_{DELAY} = 0.1\mu F$  | 7.6           | 35   | ms         |
| $I_{DELAY}$             | Charging Current for $C_{DELAY}$ |   | 10            | 30   | $\mu A$    |
| $R_{pu}$                | Internal Pull-up Resistance      |   | 12            | 80   | k $\Omega$ |

(1) Datasheet min/max specifications are ensured by design, test, and/or statistical analysis.

Typical Performance Characteristics

(T<sub>A</sub> = 25°C unless indicated otherwise)

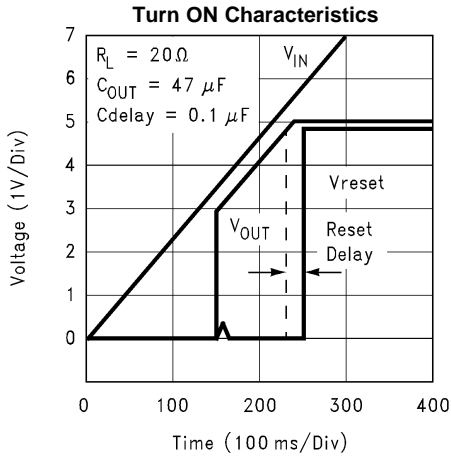


Figure 5.

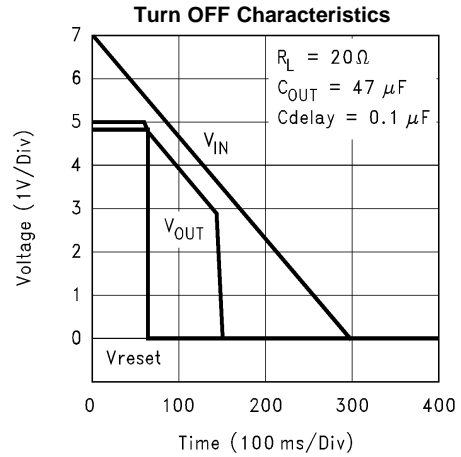


Figure 6.

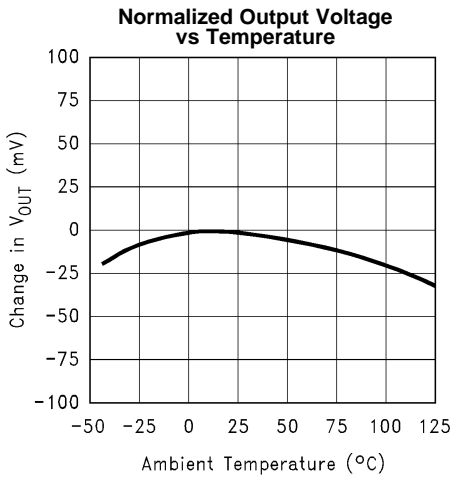


Figure 7.

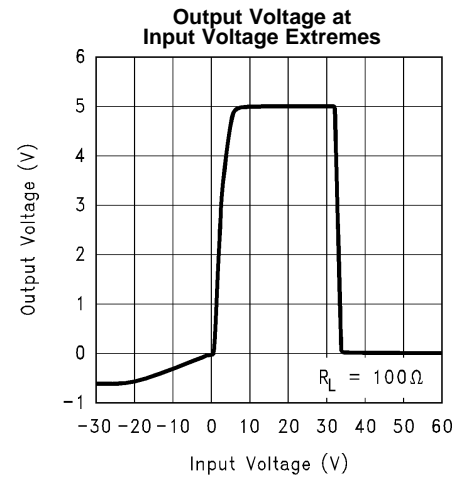


Figure 8.

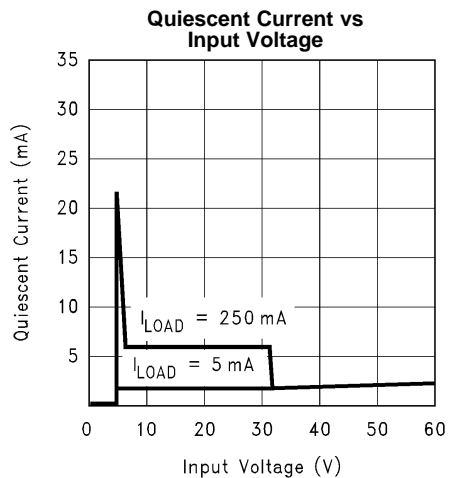


Figure 9.

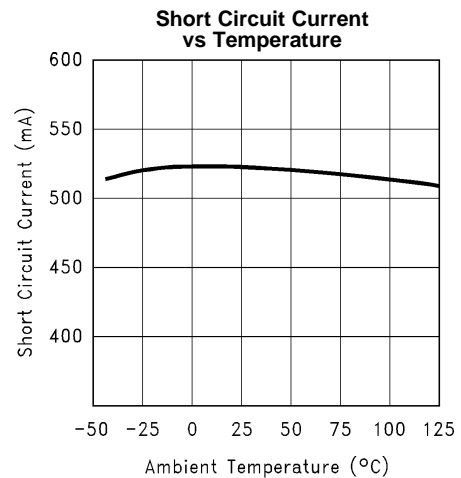


Figure 10.

Typical Performance Characteristics (continued)

( $T_A = 25^\circ\text{C}$  unless indicated otherwise)

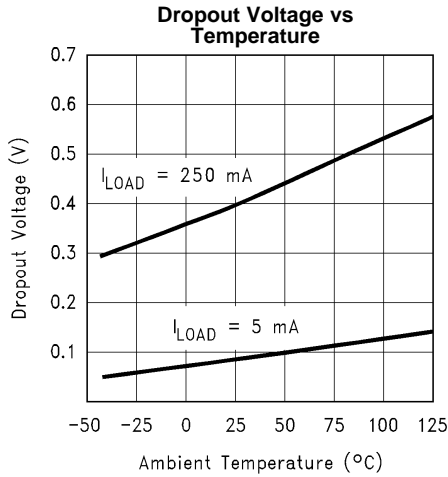


Figure 11.

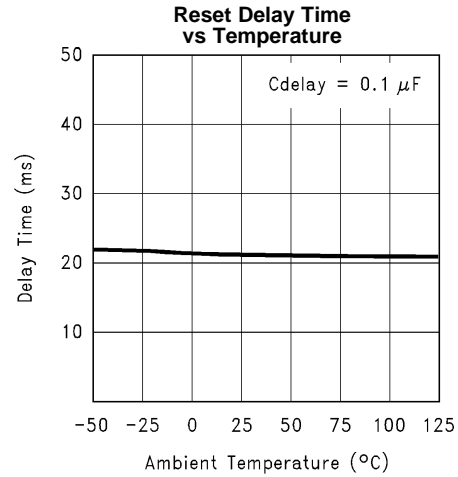


Figure 12.

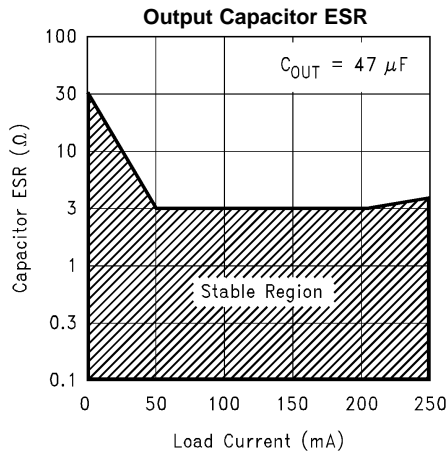


Figure 13.

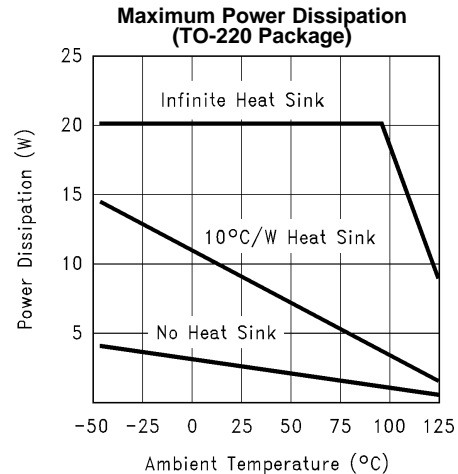


Figure 14.

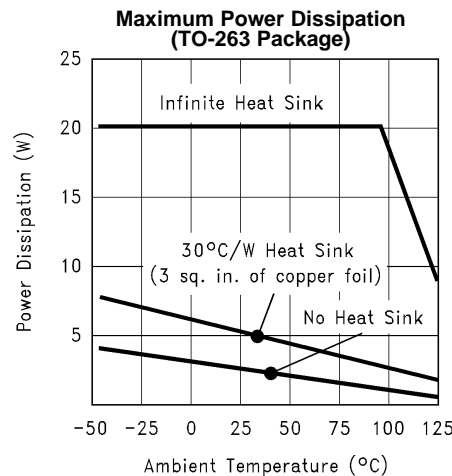
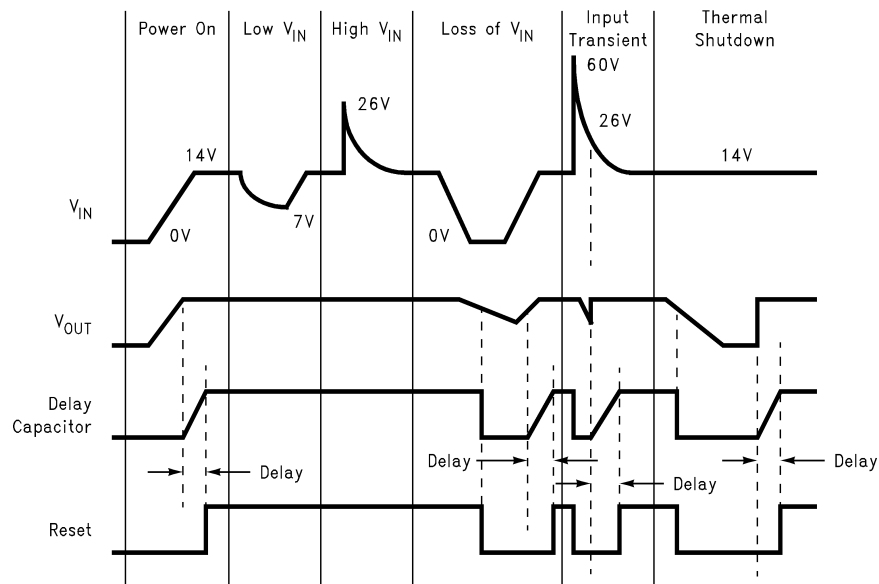
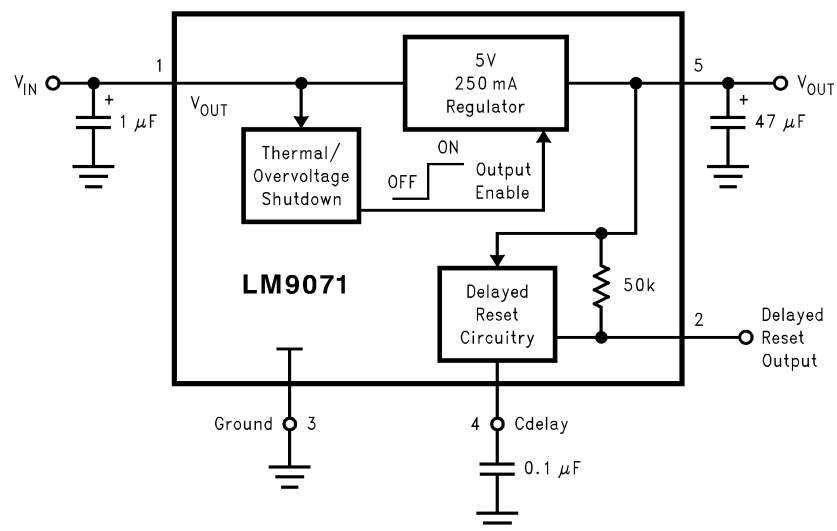


Figure 15.

## Reset Operation and Protection Features



## Block Diagram



## APPLICATION HINTS

The LM9071 voltage regulator has been optimized for use in microprocessor based automotive systems. Several unique design features have been incorporated to address many FMEA (Failure Mode Effects Analysis) concerns for fail-safe system performance.

## FAULT TOLERANT FEATURES

While not specifically ensured due to production testing limitations, the LM9071 has been tested and shown to continue to provide a regulated output and, not generate an erroneous system reset signal while subjected to high levels of RF electric field energy (up to 300 V/m signal strength over a 2 MHz to 400 MHz frequency range). This is very important in vehicle safety related applications where the system must continue to operate normally. To maintain this immunity to RFI the output bypass capacitor is important (47  $\mu$ F is recommended).

An output bypass capacitor of at least 10  $\mu\text{F}$  is required for stability (47  $\mu\text{F}$  is recommended). The ESR of this capacitor should be less than 3 $\Omega$ . An input capacitor of 1  $\mu\text{F}$  or larger is recommended to improve line transient and noise performance.

Conventional load dump protection is built in to withstand up to +60V and –50V transients. Protection against reverse polarity battery connections is also built in. With a reversed battery connection the output of the LM9071 will not go more negative than one diode drop below ground. This will prevent damage to any of the 5V load circuits.

## RESET FLAG

Excessive loading of the output to the point where the output voltage drops by 300 mV to 500 mV will signal a reset flag to the micro. This will warn of a  $V_{\text{CC}}$  supply that may produce unpredictable operation of the system. On power-up and recovery from a fault condition the delay capacitor is used to hold the micro in a reset condition for a programmable time interval to allow the system operating voltages and clock to stabilize before executing code. The delay time interval can be estimated by the following equation:

$$t_{\text{DELAY}} = \frac{3.8\text{V} \times C_{\text{DELAY}}}{20 \mu\text{A}} \quad (1)$$

## INPUT STABILITY

Low dropout voltage regulators which utilize a PNP power transistor usually exhibit a large increase in current when in dropout ( $V_{\text{IN}} < 5.5\text{V}$ ). This increase is caused by the saturation characteristics ( $\beta$  reduction) of the PNP transistor. To significantly minimize this increase in current the LM9071 detects when the PNP enters saturation and reduces the operating current.

This reduction in input current can create a stability problem in applications with higher load current (> 100 mA) where the input voltage is applied through a long length of wire, which in effect adds a significant amount of inductance in series with the input. The drop in input current may create a positive input voltage transient which may take the PNP out of saturation. If the input voltage is held constant at the threshold where the PNP is going in and out of saturation, an oscillation may be created.

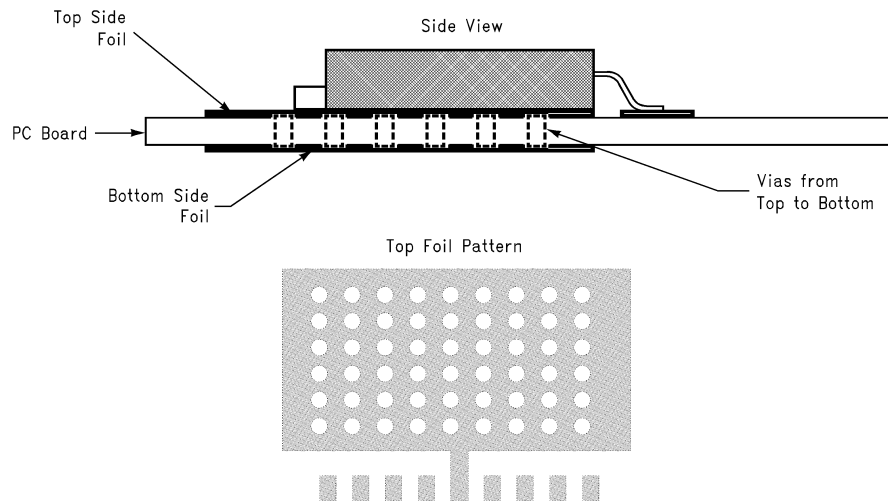
This is only observed where a large series inductance is present in the input supply line and when the rise and fall time of the input supply is very slow. If the application and removal of the input voltage changes at a rate greater than 500 mV/ $\mu\text{s}$  it will move through the dropout region of the regulator ( $V_{\text{IN}}$  of 3V to 5.5V) too quickly for an oscillation to be established.

## THERMAL MANAGEMENT

The LM9071 is packaged in both a TO-263 surface mount power package and a narrow lead-pitch TO-220 package. To obtain operation over the highest possible load current and input voltage ranges, care must be taken to control the operating temperature of the device. Thermal shutdown protection is built in, with a threshold above 150°C. Conventional heat-sinking techniques can be used with the TO-220 package. When applying the TO-263 package, on board heat-sinking is important to prevent premature thermal shutdown. More copper foil area under the tab of the device will directly improve the operating  $\theta_{\text{J-A}}$  of the TO-263 package, which will reduce the junction temperature of the device.

The  $\theta_{\text{J-A}}$  value for the TO-263 package (still air, no additional heat sink) is rated at 80°C/W. The effective  $\theta_{\text{J-A}}$  value of the TO-263 package can be reduced by increasing the printed circuit board area that is connected (soldered) to the package tab. Using 1 ounce (1.4 mils thick) copper clad with no solder mask, an area of 0.5 square inches will reduce  $\theta_{\text{J-A}}$  to 50°C/W, an area of 1.0 square inches will reduce  $\theta_{\text{J-A}}$  to 37°C/W, and an area of 1.6 square inches will reduce  $\theta_{\text{J-A}}$  to 32°C/W. If the printed circuit board uses a solder mask, the copper clad area under the solder mask should be increased by at least 50% to maintain a similar  $\theta_{\text{J-A}}$  rating.

The use of a double sided PC board with soldered filled vias between two planes of copper, as shown in [Figure 16](#), will improve thermal performance while optimizing the PC board surface area required. Using the double sided PC board arrangement shown in [Figure 16](#), with 1 ounce (1.4 mils thick) copper clad with no solder mask and solder filled vias, an area of 0.5 square inches on both sides will reduce  $\theta_{\text{J-A}}$  to 43°C/W.



**Figure 16. Typical TO-263 PC Board Heatsinking**



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**REVISION HISTORY**

| <b>Changes from Revision C (April 2013) to Revision D</b>  | <b>Page</b>    |
|--|----------------|
| <hr/> <ul style="list-style-type: none"><li>• Changed layout of National Data Sheet to TI format .....</li></ul> | <hr/> <b>8</b> |

**PACKAGING INFORMATION**

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins             | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|----------------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">LM9071S/NOPB</a>  | Active        | Production           | DDPAK/<br>TO-263 (KTT)   5 | 45   TUBE             | ROHS Exempt | SN                                   | Level-3-245C-168 HR               | -40 to 125   | LM9071S             |
| LM9071S/NOPB.B                | Active        | Production           | DDPAK/<br>TO-263 (KTT)   5 | 45   TUBE             | ROHS Exempt | SN                                   | Level-3-245C-168 HR               | -40 to 125   | LM9071S             |
| <a href="#">LM9071SX/NOPB</a> | Active        | Production           | DDPAK/<br>TO-263 (KTT)   5 | 500   LARGE T&R       | ROHS Exempt | SN                                   | Level-3-245C-168 HR               | -40 to 125   | LM9071S             |
| LM9071SX/NOPB.B               | Active        | Production           | DDPAK/<br>TO-263 (KTT)   5 | 500   LARGE T&R       | ROHS Exempt | SN                                   | Level-3-245C-168 HR               | -40 to 125   | LM9071S             |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device        | Package Type     | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|------------------|-----------------|------|-----|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM9071SX/NOPB | DDPAK/<br>TO-263 | KTT             | 5    | 500 | 330.0              | 24.4               | 10.75   | 14.85   | 5.0     | 16.0    | 24.0   | Q2            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|-----|-------------|------------|-------------|
| LM9071SX/NOPB | DDPAK/TO-263 | KTT             | 5    | 500 | 356.0       | 356.0      | 45.0        |

**TUBE**


\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| LM9071S/NOPB   | KTT          | TO-263       | 5    | 45  | 502    | 25     | 8204.2 | 9.19   |
| LM9071S/NOPB.B | KTT          | TO-263       | 5    | 45  | 502    | 25     | 8204.2 | 9.19   |

KTT0005B



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TS5B (Rev D)

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